IPC ASSOCIATION CONNECTED INDU	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both This do	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfc Information				
upplier Inf	formation								,						
Company name*			Company unique ID			Unique II	Unique ID Authority					Response Date*			
nsemi											2024-04-19				
Contact Name			Title - Contact			Phone - C	Phone - Contact*					Email - Contact*			
Product-Env-S	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Rep	presentative*		Title - Representative			Phone - I	Phone - Representative*				Email - Representative*				
Product-Env-S	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
Req	quester Item Number	Mfr Item	Number	Mfr Item Name		Effective	Date	Version	Yersion Manufacturing Site			Weight*	UOM	Unit Type	
		NCP133AMX110TCG 500mA VLDO option, Vout=1.		500mA VLDO Bias option, Vout=1.10V	s Rail CMOS Vreg, Al	2024-04	2024-04-19 PHM		HM		1.855	mg	Each		
Ianufactur	ring Proccess Informa	ition													
Terminal Plating / Grid Array Material Termin			erminal Base Alloy J-STD-020 MSL Rating			Peal	Peak Process Body Temperature Max Time at Peak					ture Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed		CU Alloy 1			260	260 C 30		30	seconds 3						
omments															
vel 1 - maxim	num time at peak temperat	ure during sol	dering is 10-3) seconds	<u> </u>					<u> </u>					
or more infor	mation regarding material	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and corrections that such information is true and corrections that such information is true and corrections that it gathered the information is true and corrections. Company acknowledges that Supplier completes this form. Supplier acknowledges that company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not or written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.09	mg	Supplier	Silicon (Si)	7440-21-3		0.09	mg
Die Attach Epoxy	0.03	mg		Epoxy resin	proprietary data		0.003	mg
			Supplier	Cumene hydroperoxide	80-15-9		0.0001	mg
			Supplier	Diethylene glycol monoethyl ether acetate	112-15-2		0.0014	mg
			Supplier	Silver (Ag)	7440-22-4		0.0255	mg
Lead Frame	0.82	mg	Supplier	Silver (Ag)	7440-22-4		0.0328	mg
			Supplier	Tin (Sn)	7440-31-5		0.0021	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0018	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0021	mg
			Supplier	Copper (Cu)	7440-50-8		0.7813	mg
Mold Compound-Black	0.88	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.0704	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0044	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0176	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.7612	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0264	mg
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg
Wire Bond	0.015	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0147	mg